



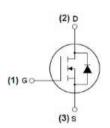
MJ N-Channel Enhancement Mode Power MOSFET

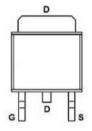
Description

The MJ1826K uses advanced trench technology and design to provide excellent $R_{\text{DS}(\text{ON})}$ with low gate charge. It can be used in a wide variety of applications.

General Features

- ♦ $V_{DS} = 185V, I_{D} = 26A$ $R_{DS(ON)} < 60m\Omega$ @ $V_{GS} = 10V$ (Typ:50mΩ)
- ◆ High density cell design for ultra low Rdson
- ◆ Fully characterized avalanche voltage and current
- ◆ Good stability and uniformity with high EAS
- Excellent package for good heat dissipation
- ◆ Special process technology for high ESD capability



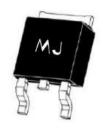


Application

◆ Power switching application

Uninterruptible power supply

Hard switched and high frequency circuits



Schematic diagram

Marking and pin assignment

TO-252-2L top view

100% UIS TESTED! 100% ΔVds TESTED!

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
MJ1826K	MJ1826K	TO-252-2L	ii ii	-	2

Absolute Maximum Ratings (Tc =25 ℃unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	VDS	185	V
Gate-Source Voltage	Vgs	±20	V
Drain Current-Continuous	lD	26	А
Drain Current-Continuous(Tc =100°C)	I _D (100℃)	18.4	А
Pulsed Drain Current	Ідм	100	А
Maximum Power Dissipation	Po	150	W
Single pulse avalanche energy (Note 5)	Eas	25	mJ
Operating Junction and Storage Temperature Range	Тл,Тѕтс	-55 To 175	°C

Thermal Characteristic

Thermal Resistance, Junction-to-Case (Note 2)	RөJC	1	°C/W
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Electrical Characteristics (Tc =25°Cunless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BVDSS	V _{GS} =0V I _D =250µA	185	_	-	V
Zero Gate Voltage Drain Current	loss	V _{DS} =185V,V _{GS} =0V	-	-	1	μA
Gate-Body Leakage Current	lgss	V _{DS} =±20V,V _{DS} =0V	-	-	±100	nA
On Characteristics (Note 3)	·					
Gate Threshold Voltage	VGS(th)	V _{DS} =V _{GS} ,I _D =250µA	2.0	3.0	4.0	V
Drain-Source On-State Resistance	Rds(on)	V _{GS} =10V, I _D =15A	-	50	60	mΩ
Forward Transconductance	g FS	V _{DS} =5V,I _D =10A	17	-	-	S
Dynamic Characteristics (Note 4)		1	ı			1
Input Capacitance	Clss		-	4118	-	PF
Output Capacitance	Coss	V _{DS} =50V,V _{GS} =0V F=1.0MHz	-	120	-	PF
Reverse Transfer Capacitance	Crss	-	-	91	_	PF
Switching Characteristics (Note 4)						
Turn-on Delay Time	t _{d(on)}		-	10	-	nS
Turn-on Rise Time	tr	VDD=100V,ID=15A	-	18	-	nS
Turn-Off Delay Time	t _{d(off)}	Vgs=10V,Rgen=2.5Ω	-	22	-	nS
Turn-Off Fall Time	tr	_	-	5	-	nS
Total Gate Charge	Qg		-	90.7	-	nC
Gate-Source Charge	Qgs	V _{DS} =100V,I _D =15A V _{GS} =10V	-	17.4	-	nC
Gate-Drain Charge	Qgd		-	30.4	-	nC
Drain-Source Diode Characteristics						
Diode Forward Voltage (Note 3)	Vsp	V _{GS} =0V,I _S =15A	-	_	1.2	V
Diode Forward Current (Note 2)	ls		-	_	26	А
Reverse Recovery Time	trr	TJ=25°C, IF=15A	-	90	_	nS
Reverse Recovery Charge	Qrr	di/dt=100A/µs (Note 3)	-	300	-	nC
Forward Turn-On Time	ton	Intrinsic turn-on time is no	ealiaible/ti	ırn-on is d	ominated h	ov I S+I D

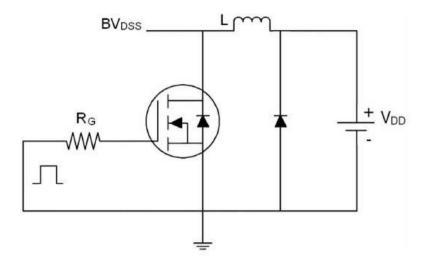
Notes:

- $\ensuremath{\mathfrak{D}}$ Repetitive Rating: Pulse width limited by maximum junction temperature.
- ② Surface Mounted on FR4 Board, t ≤ 10 sec.
- ③ Pulse Test: Pulse Width ≤ 300 μ s, Duty Cycle ≤ 2%.
- 4 Guaranteed by design, not subject to production
- (§) EAS condition: Tj=25°C,VDD=100V,VG=10V,L=0.5mH,Rg=25 Ω

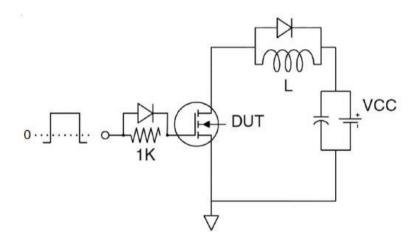




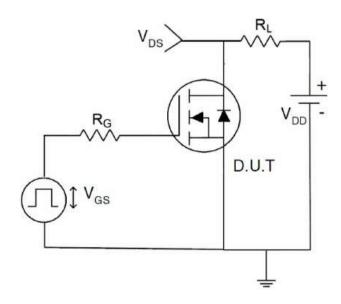
Test circuit



Eas test Circuit



Gate charge test Circuit



Switch Time Test Circuit



40

30

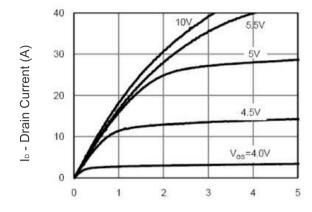
20

10

0

lo - Drain Current (A)

Typical Electrical and Thermal Characteristics (Curves)



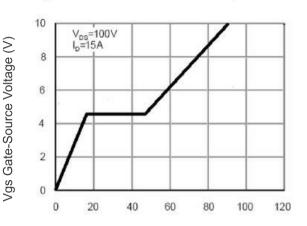
2.8
2.6
2.4
2.2
0 Parity

1.8
1.6
1.4
1.2
1
0.8
0 25 50 75 100 125 150 175 200

Vds Drain-Source Voltage (V)
Figure 1 Output Characteristics

V_{ps}=5V 125° C 25° C

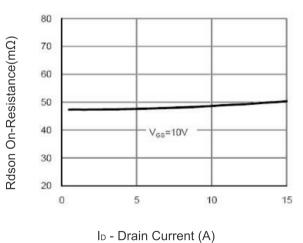
TJ -Junction Temperature(°C)
Figure 4 Rdson-Junction Temperature



Vgs Gate-Source Voltage (V)
Figure 2 Transfer Characteristics

4

3



Qg Gate Charge (nC)
Figure 5 Gate Charge

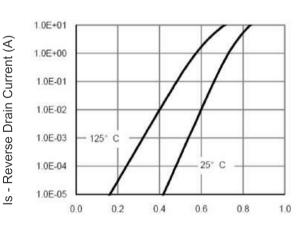
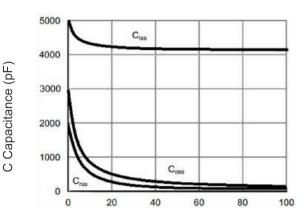


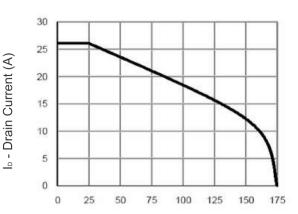
Figure 3 Rdson- Drain Current

Vsd Source-Drain Voltage (V)
Figure 6 Source- Drain Diode Forward



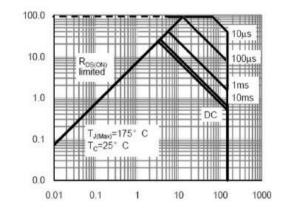
lo - Drain Current (A)

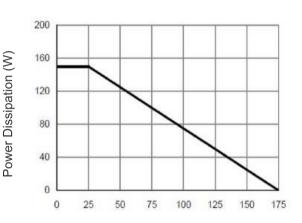




Vds Drain-Source Voltage (V) Figure 7 Capacitance vs Vds

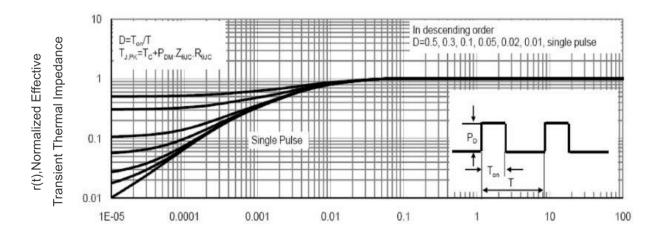
T_J -Junction Temperature(°C) Figure 9 Current De-rating





Vds Drain-Source Voltage (V) Figure 8 Safe Operation Area

T_J -Junction Temperature(°C) Figure 10 Power De-rating



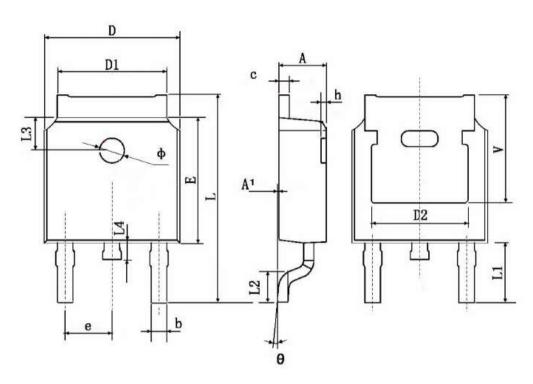
Square Wave Pluse Duration(sec)

Figure 11 Normalized Maximum Transient Thermal Impedance





TO-252 Package Information



Symbol	Dimensions	In Millimeters	Dimension	s In Inches
	Min.	Max.	Min.	Max.
Α	2.200	2.400	0.087	0.094
A1	0.000	0.127	0.000	0.005
b	0.660	0.860	0.026	0.034
С	0.460	0.580	0.018	0.023
D	6.500	6.700	0.256	0.264
D1	5.100	5.460	0.201	0.215
D2	4.8	30 TYP.	0.190 TYP.	
E	6.000	6.200	0.236	0.244
е	2.186	2.386	0.086	0.094
L	9.800	10.400	0.386	0.409
L1	2.900	TYP.	0.114	TYP.
L2	1.400	1.700	0.055	0.067
L3	1.600	TYP.	0.063	TYP.
L4	0.600	1.000	0.024	0.039
Ф	1.100	1.300	0.043	0.051
θ	0°	8°	0.	8°
h	0.000	0.300	0.000	0.012
V	5.350 TYP.		0.211	TYP.





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